



Date: 12/7/2017

Title: LS to establish collaboration between IIC and 3GPP

Response to:

Source: IIC Liaison Working Group

From: Wael William Diab (IIC Liaison Working Group Chair) wael.william.diab@huawei.com

To: 3GPP TSG SA, 3GPP TSG SA WG1

LS sent to 3GPP Liaisons Coordinator, 3GPPLiaison@etsi.org

Cc:

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Attachments: N/A

The Industrial Internet Consortium (IIC) would like to establish a liaison between IIC and 3GPP. We think that collaboration between our organizations would be mutually beneficial.

Suggestions for areas of collaboration include:

- Industrial IoT use cases, requirements and architectures
- Gaps in standards to address emerging use cases
- Feedback on standards from IIC testbeds /interoperability events

Suggestions for our method of collaboration include:

- Exchange of liaison statements to seek feedback on specific issues and deliverables
- Joint conference calls
- Exchange deliverables and seek peer feedback
- Joint workshop as needed

IIC asks 3GPP to take the above into account in developing this liaison relationship.

Best regards,

Wael William Diab

IIC Liaison Working Group Chair